

## Low capacitance small signal Schottky diodes

### Features

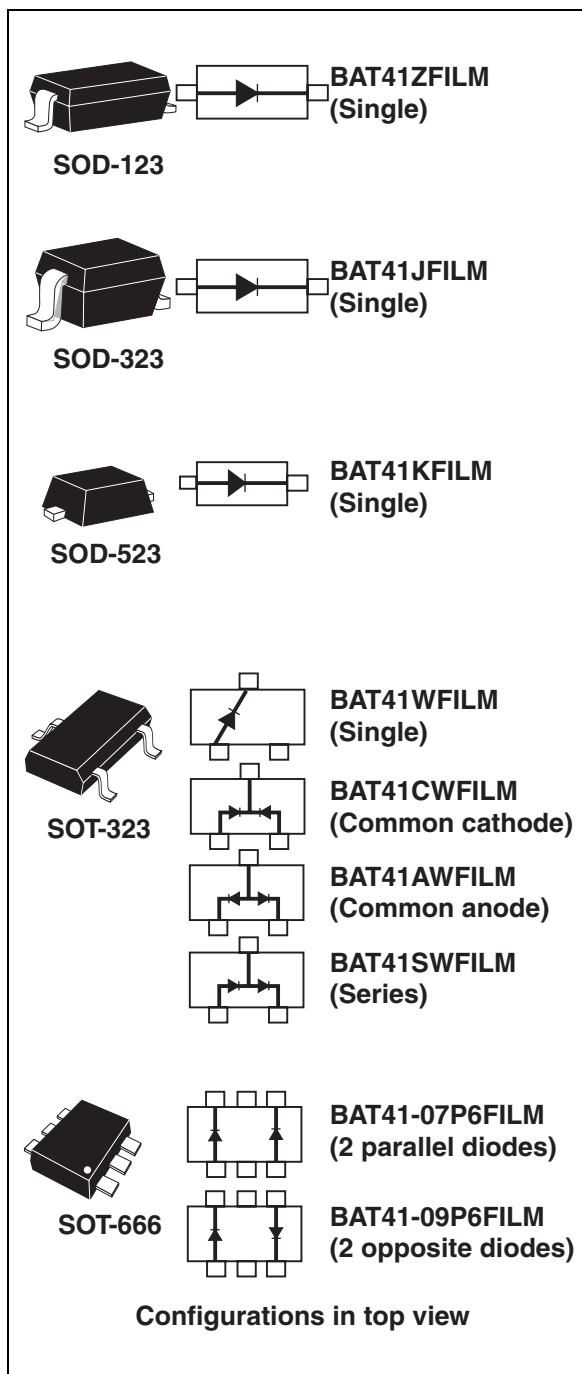
- Low leakage current losses
- Negligible switching losses
- Low forward and reverse recovery times
- Extremely fast switching
- Surface mount device
- Low capacitance diode

### Description

The BAT41 series uses 100 V Schottky barrier diodes packaged in SOD-123, SOD-323, SOD-523, SOT-323, or SOT-666. This series is specially suited for switching mode with low  $I_F$  losses

**Table 1. Device summary**

Symbol	Value
$I_F$	200 mA
$V_{RRM}$	100 V
C(typ)	3 pF
$T_j$ (max)	150 °C



# 1 Characteristics

**Table 2. Absolute ratings (limiting values at  $T_j = 25\text{ °C}$ , unless otherwise specified)**

Symbol	Parameter	Value	Unit
$V_{RRM}$	Repetitive peak reverse voltage	100	V
$I_F$	Continuous forward current	200	mA
$I_{FSM}$	Surge non repetitive forward current	$t_p = 10\text{ ms}$ Sinusoidal	A
$T_{stg}$	Storage temperature range	-65 to +150	°C
$T_j$	Maximum operating junction temperature	150	°C

**Table 3. Thermal parameters**

Symbol	Parameter	Value	Unit
$R_{th(j-a)}$	Junction to ambient <sup>(1)</sup>	SOD-123	500
		SOT-323, SOD-323	550
		SOD-523, SOT-666	600
			°C/W

1. Epoxy printed circuit board with recommended pad layout

**Table 4. Static electrical characteristics**

Symbol	Parameter	Test conditions	Min.	Typ.	Max.	Unit	
$I_R^{(1)}$	Reverse leakage current	$T_j = 25\text{ °C}$	$V_R = 50\text{ V}$		0.1	$\mu\text{A}$	
		$T_j = 100\text{ °C}$			20		
$V_F^{(2)}$	Forward voltage drop	$T_j = 25\text{ °C}$	$I_F = 1\text{ mA}$		400	450	mV
			$I_F = 200\text{ mA}$			1000	

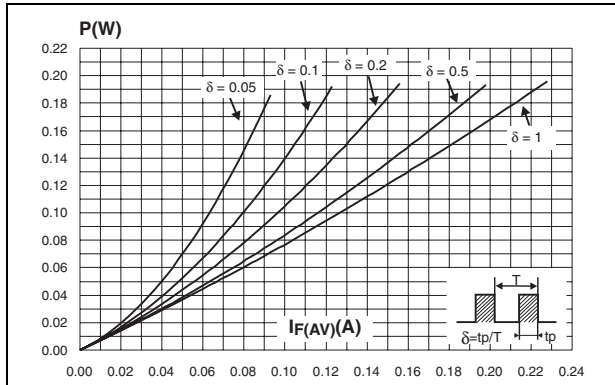
1. Pulse test:  $t_p = 5\text{ ms}$ ,  $\delta < 2\%$

2. Pulse test:  $t_p = 380\text{ }\mu\text{s}$ ,  $\delta < 2\%$

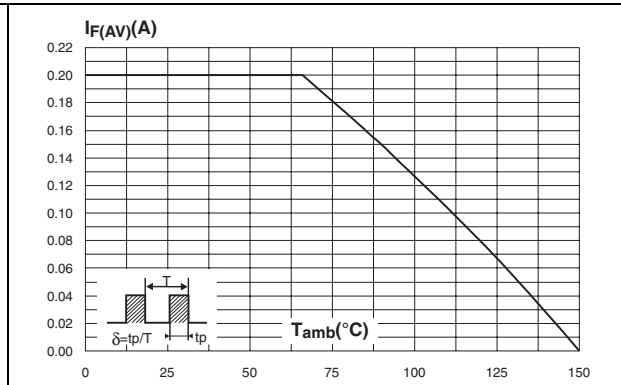
**Table 5. Dynamic characteristics**

Symbol	Parameter	Test conditions	Min.	Typ.	Max.	Unit
C	Diode capacitance	$V_R = 1\text{ V}$ , $F = 1\text{ MHz}$		3	10	pF

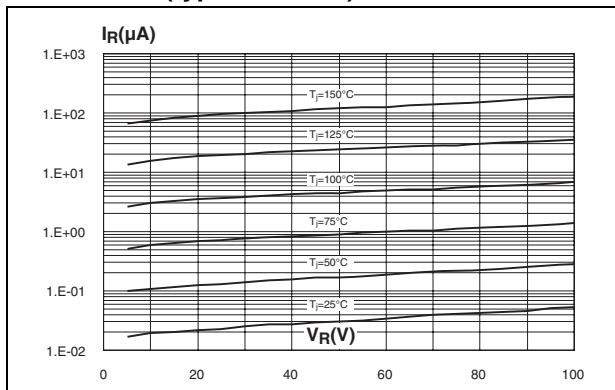
**Figure 1. Average forward power dissipation versus average forward current**



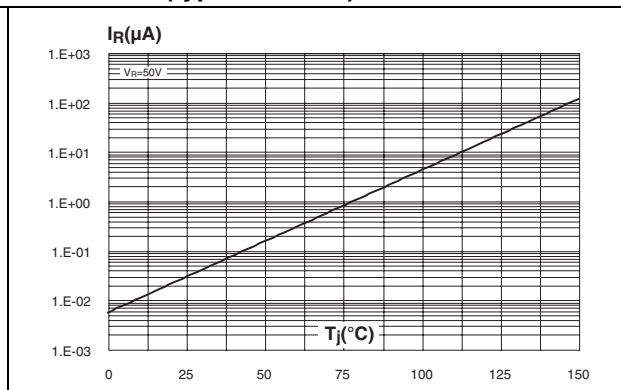
**Figure 2. Average forward current versus ambient temperature (delta = 1)**



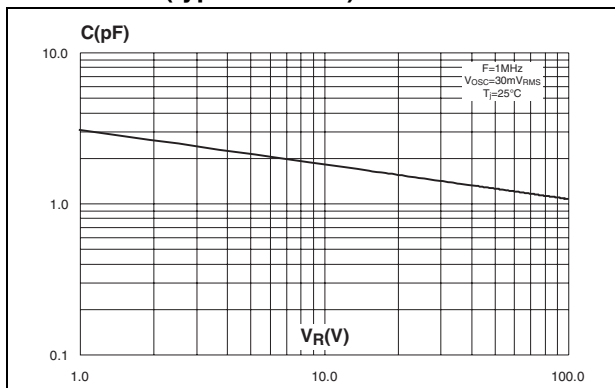
**Figure 3. Reverse leakage current versus reverse applied voltage (typical values)**



**Figure 4. Reverse leakage current versus junction temperature (typical values)**



**Figure 5. Junction capacitance versus reverse applied voltage (typical values)**



**Figure 6. Forward voltage drop versus forward current (typical values)**

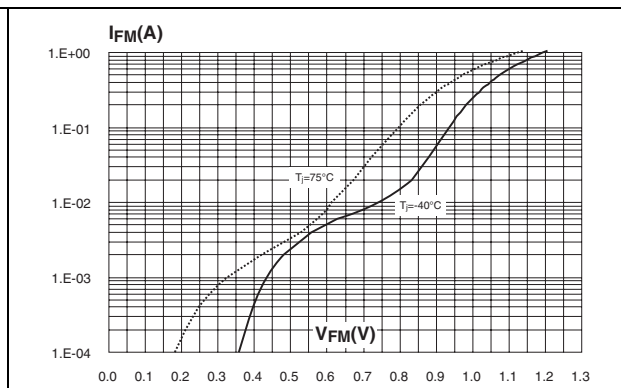


Figure 7. Forward voltage drop versus forward current (typical values)

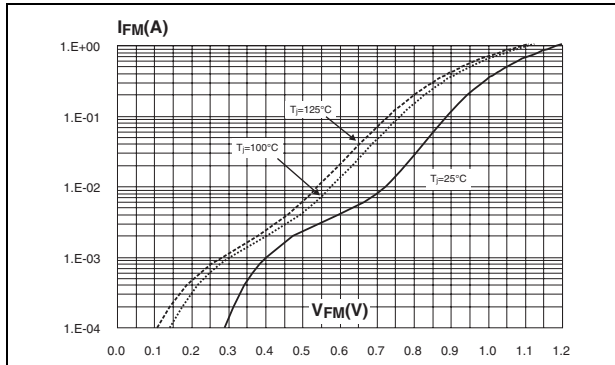


Figure 8. Variation of thermal impedance junction to ambient versus pulse duration

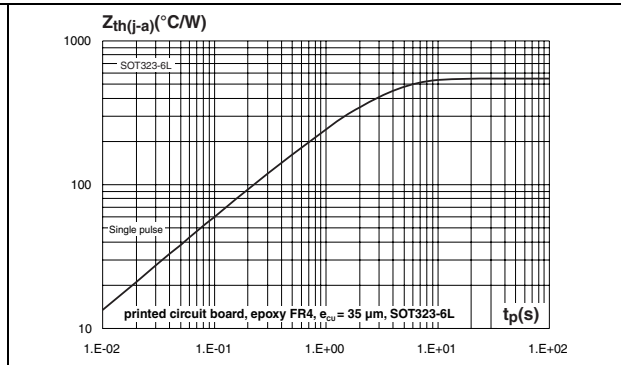


Figure 9. Relative variation of thermal impedance junction to ambient versus pulse duration

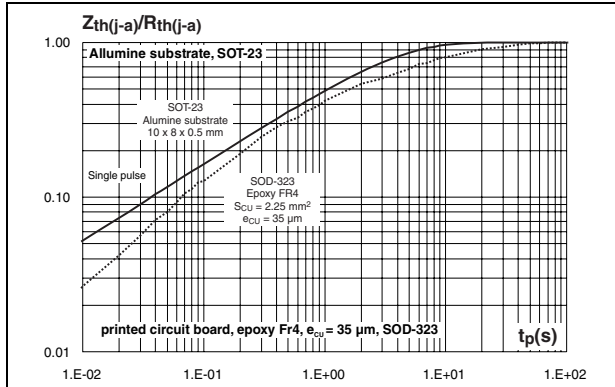


Figure 10. Relative variation of thermal impedance junction to ambient versus pulse duration

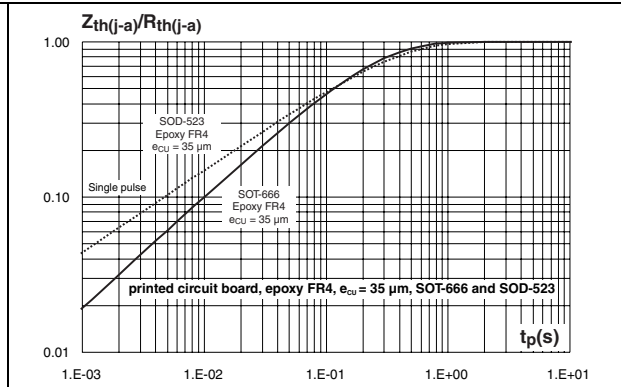
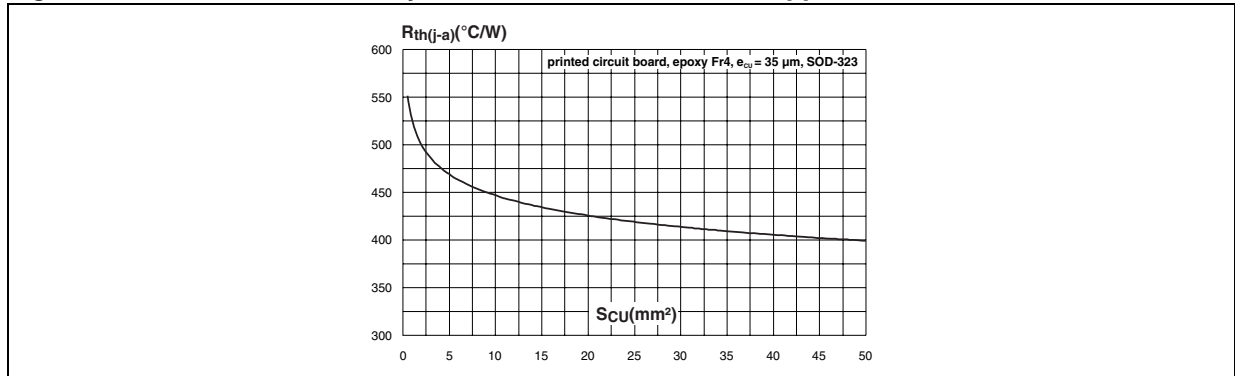
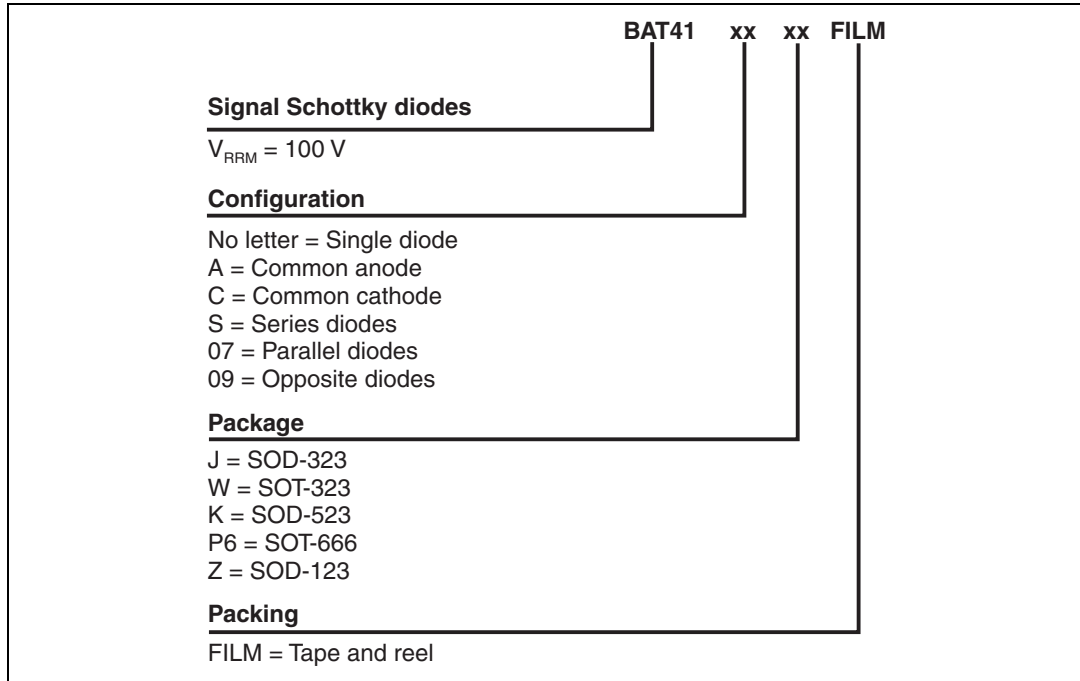


Figure 11. Thermal resistance junction to ambient versus copper surface under each lead



## 2 Ordering information scheme

Figure 12. Ordering information scheme



### 3 Package information

- Epoxy meets UL94, V0
- Lead-free packages

In order to meet environmental requirements, ST offers these devices in different grades of ECOPACK® packages, depending on their level of environmental compliance. ECOPACK® specifications, grade definitions and product status are available at: [www.st.com](http://www.st.com). ECOPACK® is an ST trademark.

**Table 6. SOD-123 dimensions**

Ref.	Dimensions			
	Millimeters		Inches	
	Min.	Max.	Min.	Max.
A		1.45		0.057
A1	0	0.1	0	0.004
A2	0.85	1.35	0.033	0.053
b	0.55 Typ.		0.022 Typ.	
c	0.15 Typ.		0.039 Typ.	
D	2.55	2.85	0.1	0.112
E	1.4	1.7	0.055	0.067
G	0.25		0.01	
H	3.55	3.95	0.14	0.156

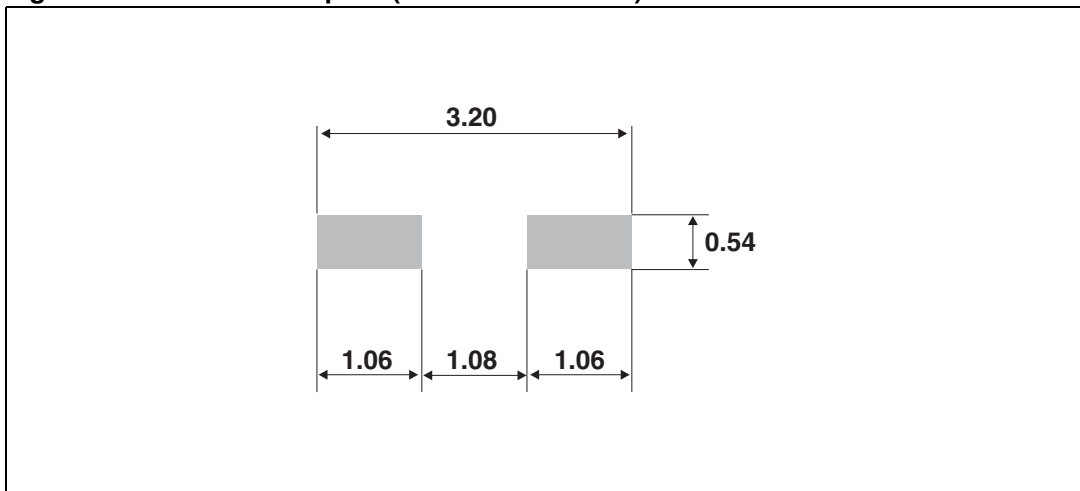
**Figure 13. SOD-123 footprint (dimensions in mm)**



**Table 7. SOD-323 dimensions**

Ref.	Dimensions			
	Millimeters		Inches	
	Min.	Max.	Min.	Max.
A		1.17		0.046
A1	0	0.1	0	0.004
b	0.25	0.44	0.01	0.017
c	0.1	0.25	0.004	0.01
D	1.52	1.8	0.06	0.071
E	1.11	1.45	0.044	0.057
H	2.3	2.7	0.09	0.106
L	0.1	0.46	0.004	0.02
Q1	0.1	0.41	0.004	0.016

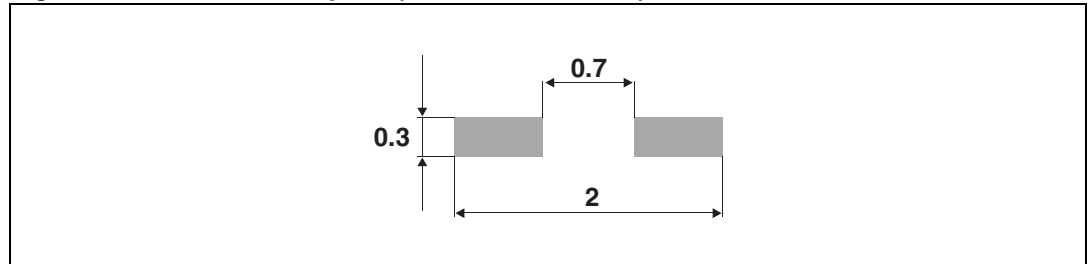
**Figure 14. SOD-323 footprint (dimensions in mm)**



**Table 8. SOD-523 dimensions**

Ref.	Dimensions					
	Millimeters			Inches		
	Min.	Typ.	Max.	Min.	Typ.	Max.
A	0.50	0.60	0.70	0.020	0.024	0.028
E	1.50	1.60	1.70	0.059	0.063	0.067
E1	1.10	1.20	1.30	0.043	0.047	0.051
D	0.70	0.80	0.90	0.028	0.031	0.035
b	0.25		0.35	0.010		0.014
c	0.07		0.20	0.003		0.008
L	0.15	0.20	0.25	0.006	0.008	0.010
L1	0.05		0.20	0.002		0.008

**Figure 15. SOD-523 footprint (dimensions in mm)**





**Table 9. SOT-323 dimensions**

Ref.	Dimensions					
	Millimeters			Inches		
	Min.	Typ.	Max.	Min.	Typ.	Max.
A	0.8		1.1	0.031		0.043
A1	0.0		0.1	0.0		0.004
b	0.25		0.4	0.010		0.016
c	0.1		0.26	0.004		0.010
D	1.8	2.0	2.2	0.071	0.079	0.086
E	1.15	1.25	1.35	0.045	0.049	0.053
e		0.65			0.026	
H	1.8	2.1	2.4	0.071	0.083	0.094
L	0.1	0.2	0.3	0.004	0.008	0.012
q	0		30°	0		30°

**Figure 16. SOT-323 footprint (dimensions in mm)**

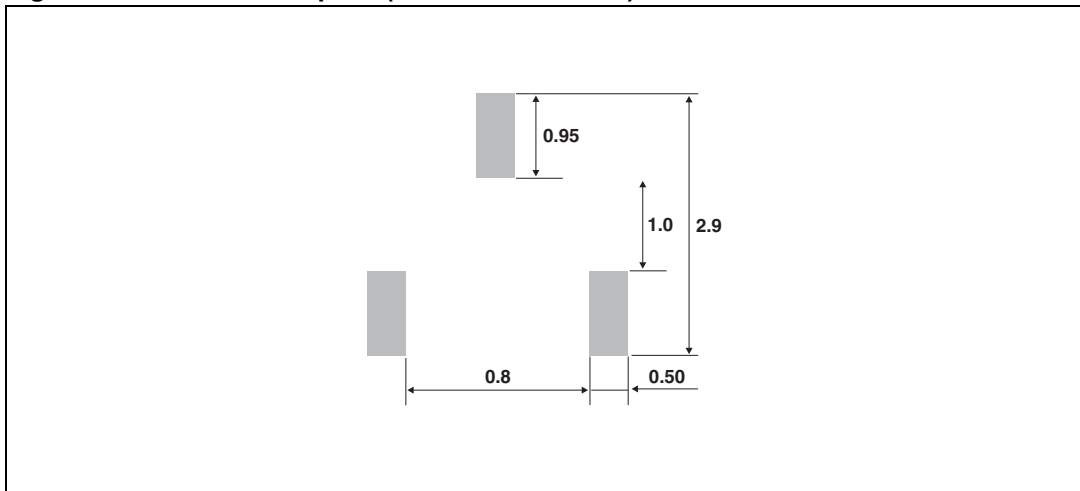
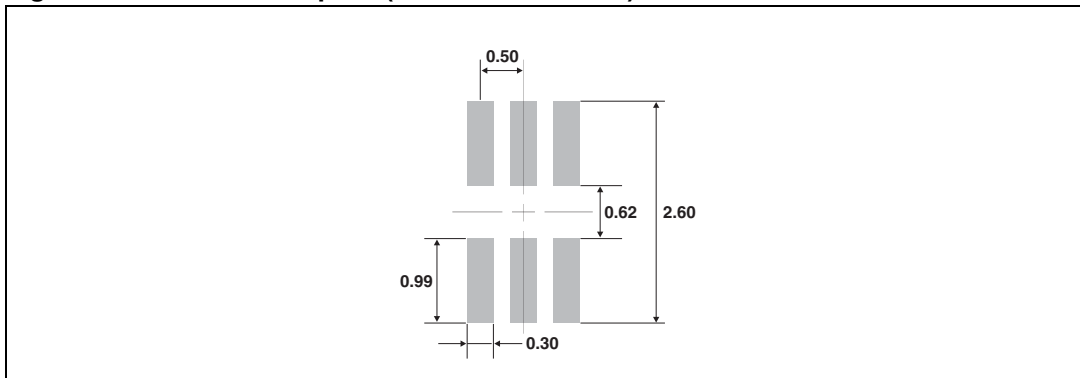


Table 10. SOT-666 dimensions

Ref.	Dimensions					
	Millimeters			Inches		
	Min.	Typ.	Max.	Min.	Typ.	Max.
A	0.45		0.60	0.018		0.024
A3	0.08		0.18	0.003		0.007
b	0.17		0.34	0.007		0.013
b1	0.19	0.27	0.34	0.007	0.011	0.013
D	1.50		1.70	0.059		0.067
E	1.50		1.70	0.059		0.067
E1	1.10		1.30	0.043		0.051
e		0.50			0.020	
L1		0.19			0.007	
L2	0.10		0.30	0.004		0.012
L3		0.10			0.004	

Figure 17. SOT-666 footprint (dimensions in mm)



## 4 Ordering information

**Table 11. Ordering information**

Order code	Marking	Package	Weight	Base qty	Delivery mode
BAT41ZFILM	Z41	SOD-123 Single	10 mg	3000	Tape and reel
BAT41WFILM	B41	SOT-323 Single	6 mg	3000	Tape and reel
BAT41SWFILM	S41	SOT-323 Series	6 mg	3000	Tape and reel
BAT41CWFILM	C41	SOT-323 Common cathode	6 mg	3000	Tape and reel
BAT41AWFILM	A41	SOT-323 Common anode	6 mg	3000	Tape and reel
BAT41JFILM	41	SOD-323 Single	5 mg	3000	Tape and reel
BAT41KFILM	41	SOD-523 Single	1.4 mg	3000	Tape and reel
BAT41-09P6FILM	Q1	SOT-666 Opposite	2.9 mg	3000	Tape and reel
BAT41-07P6FILM	P1	SOT-666 Parallel	2.9 mg	3000	Tape and reel

## 5 Revision history

**Table 12. Document revision history**

Date	Revision	Changes
08-Aug-2006	1	Initial release.
12-Oct-2009	2	Updated Table 8 quote "L1" from 0.10 to 0.05.

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